

WMS30N420K N-Channel Silicon MOSFET Rev.02 - 18 June 2024

**Product data sheet** 

## 1. General description

WMS30N420K is a high performance logic level N-channel MOSFET in SOT23 package, which utilizes advanced Trench MOSFET technology to provide low  $R_{DS(on)}$  and gate charge. It is designed and qualified in a wide range of industrial and consumer applications.



### 2. Features and benefits

- · High ESD sensitivity devices
- Advance High Cell Density Trench Technology
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Switching Losses
- Optimized Gate Charge to Minimize Driver Losses
- RoHS Compliant, Halogen Free and Lead Free

# 3. Applications

- Load Switch
- General PWM Applications

## 4. Quick reference data

Table 1. Qu	uick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
V <sub>DS</sub>	drain-source voltage				30	·	V
V <sub>GS</sub>	gate-source voltage				±20		V
I <sub>D</sub>	continuous drain current	V <sub>GS</sub> = 10 V; T <sub>a</sub> = 25 °C			4.8		А
P <sub>tot</sub>	power dissipation	T <sub>a</sub> = 25 °C		1.4		W	
T <sub>j</sub>	junction temperature			-55 to 150		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics	^					
R <sub>DS(on)</sub> drain-source on-state resistance		$V_{GS}$ = 10 V, I <sub>D</sub> = 4.8 A		-	35	42	mΩ
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 3 A		-	46	65	mΩ
Dynamic characteristics							·
Q <sub>G(tot)</sub>	total gate charge	$I_{D}$ = 4.8 A; $V_{DS}$ = 15 V; $V_{GS}$ = 10 V		-	5.1	-	nC

# 5. Pinning information

Table 2. P	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	G	gate	2	П				
2	S	source						
3	D	drain		G sym300 S				

# 6. Ordering information

Table 3. Ordering information						
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WMS30N420K	SOT23	WMS30N420KX	Reel	3000	SOT23L	22-Aug-2022

# 7. Marking

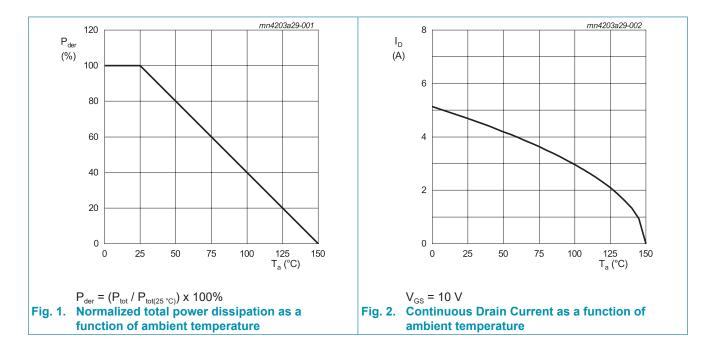
Table 4. Marking codes	
Type number	Marking codes
WMS30N420K	AG

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V <sub>DS</sub>	drain-source voltage			30	V
$V_{GS}$	gate-source voltage			±20	V
I <sub>D</sub>	continuous drain current	V <sub>GS</sub> = 10 V; T <sub>a</sub> = 25 °C		4.8	А
		V <sub>GS</sub> = 10 V; T <sub>a</sub> = 70 °C		3.8	А
I <sub>DM</sub>	pulsed drain current	t <sub>p</sub> = 10 μs; T <sub>a</sub> = 25 °C		19	А
P <sub>tot</sub>	power dissipation	T <sub>a</sub> = 25 °C		1.4	W
T <sub>stg</sub>	storage temperature			-55 to 150	°C
T <sub>j</sub>	junction temperature			-55 to 150	°C

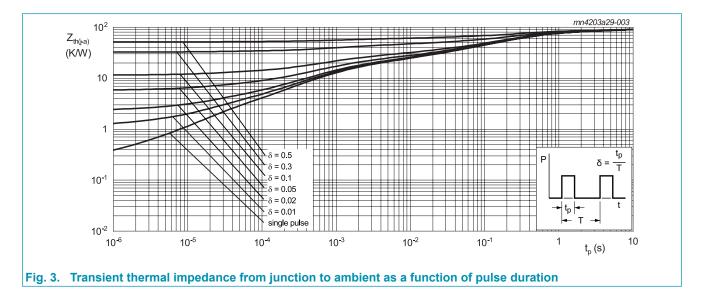


# 9. Thermal & Mechanical characteristics

	able 6. Thermal & Mechanical characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
$R_{th(j-a)}$	thermal resistance	t ≤ 10s	[1]	-	72	90	K/W	
	from junction to ambient	in free air	[1]	-	95	120	K/W	

 Table 6. Thermal & Mechanical characteristics

[1] Surface mount on FR4 board of 1 inch<sup>2</sup>, 1 oz copper.

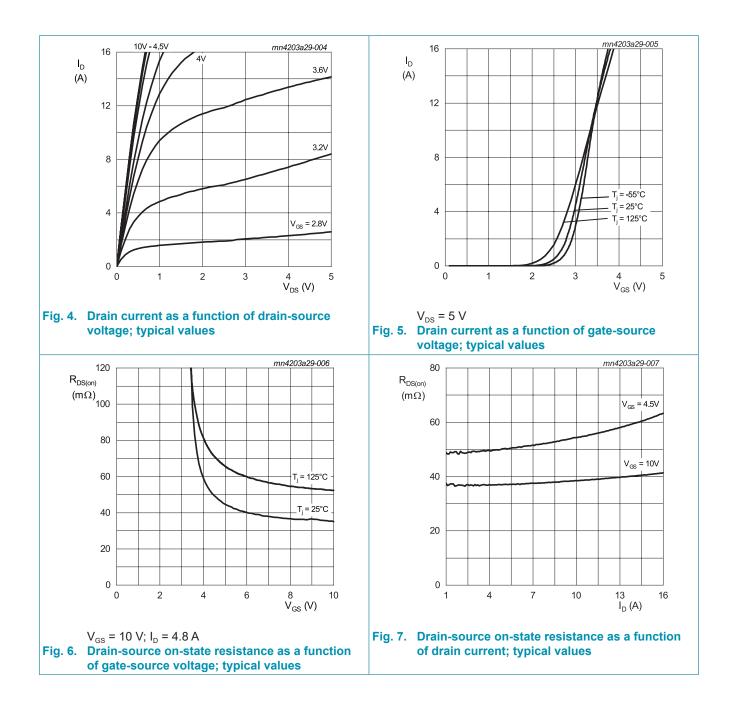


# **10. Characteristics**

### Table 7. Characteristics

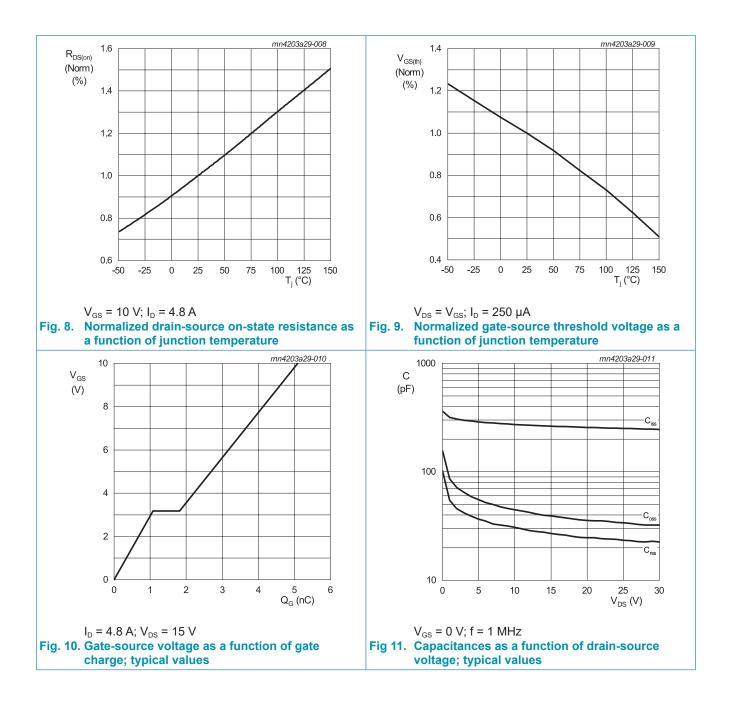
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$V_{(\text{BR})\text{DSS}}$	drain-source breakdown voltage	$I_{D} = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V$		30	-	-	V
$V_{\text{GS(th)}}$	gate-source threshold voltage	$I_D$ = 250 µA; $V_{DS}$ = $V_{GS}$		1	1.6	2.4	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 30 V; $V_{GS}$ = 0 V		-	-	1	μA
		$V_{DS}$ = 30 V; $V_{GS}$ = 0 V; $T_j$ = 125 °C		-	-	10	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0 \text{ V}$		-	-	±100	nA
$R_{\text{DS(on)}}$	drain-source on-state	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 4.8 A		-	35	42	mΩ
	resistance	V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 3 A		-	46	65	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz		-	4.3	-	Ω
Dynamic	characteristics	·					
Q <sub>G(tot)</sub>	total gate charge	$I_{D}$ = 4.8 A; $V_{DS}$ = 15 V; $V_{GS}$ = 10 V		-	5.1	-	nC
Q <sub>GS</sub>	gate-source charge			-	1.1	-	nC
Q <sub>GD</sub>	gate-drain charge			-	0.7	-	nC
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 15 V; V <sub>GS</sub> = 0 V; f = 1 MHz		-	264	-	pF
C <sub>oss</sub>	output capacitance			-	39	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	27	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 15 V; V_{GS} = 10 V; R_{G} = 6 \Omega;$		-	2.1	-	ns
t <sub>r</sub>	rise time	$I_{\rm D} = 4.8  {\rm A}$		-	1.1	-	ns
$t_{d(off)}$	turn-off delay time			-	6.7	-	ns
t <sub>f</sub>	fall time			-	3.2	-	ns
Source-d	rain diode						
V <sub>SD</sub>	source-drain voltage	V <sub>GS</sub> = 0 V; I <sub>S</sub> = 1 A		-	0.78	1	V
		V <sub>GS</sub> = 0 V; I <sub>S</sub> = 1 A; T <sub>j</sub> = 125 °C		-	0.64	-	V
ls	body-diode continuous current	T <sub>a</sub> = 25 °C		-	-	2	A
t <sub>rr</sub>	reverse recovery time	$V_{GS}$ = 0 V; I <sub>S</sub> = 4.8 A; di/dt = 100 A/µs		-	12	-	ns
Q <sub>rr</sub>	reverse recovered charge	1		-	5.7	-	nC
I <sub>rrm</sub>	reverse recovery current			-	0.8	-	А

**N-Channel Silicon MOSFET** 



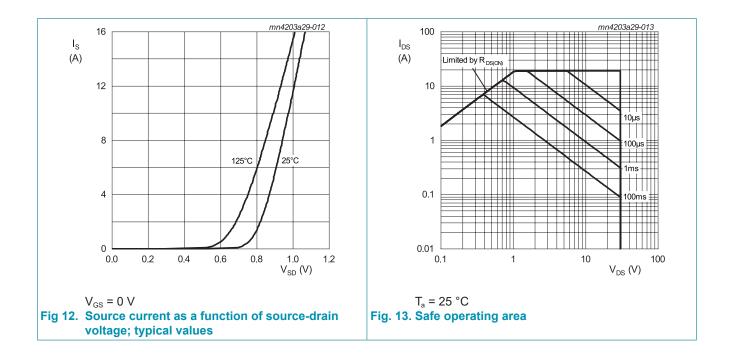
## **WMS30N420K**

**N-Channel Silicon MOSFET** 

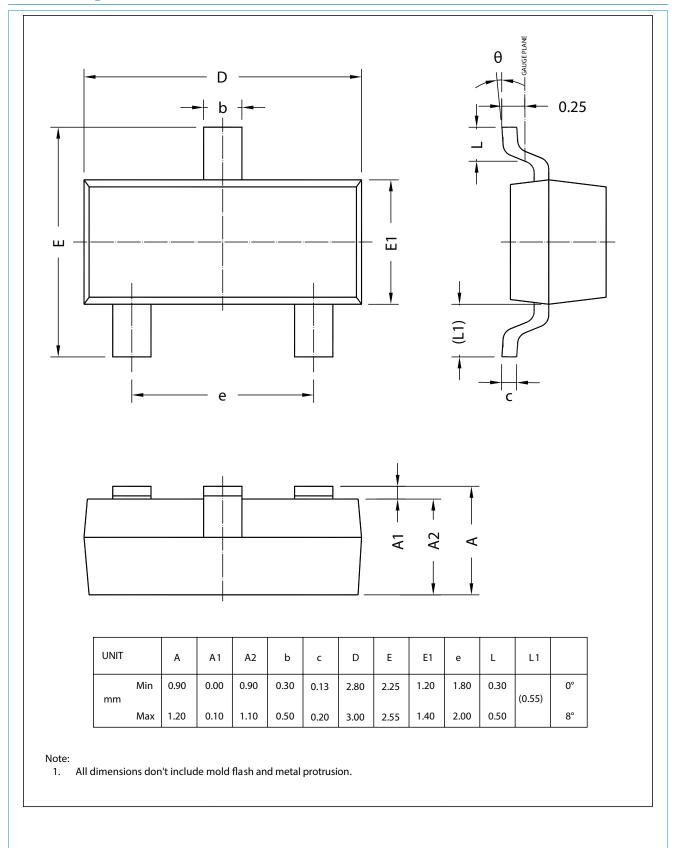


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**WMS30N420K** 



# **11. Package outline**



### WMS30N420K

#### **N-Channel Silicon MOSFET**

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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